1-178297-5 - ACTIVE

Dynamic Series | Dynamic 3000 Series

TE Internal #: 1-178297-5 PCB Mount Header, Horizontal, Wire-to-Board, 8 Position, 3.81 mm [.15 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Dynamic 3000 Series

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 15A, gold or tin plated



Connector System: Wire-to-Board Number of Positions: **8**

Number of Rows: 1

Centerline (Pitch): 3.81 mm [.15 in]

PCB Mount Orientation: Horizontal

All Header Assembly: Wire-to-Board, 15A, gold or tin plated (120)



Features

Product Type Features

Connector System	Wire-to-Board			
Header Type	Fully Shrouded			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
PCB Connector Assembly Type	PCB Mount Header			
Configuration Features				
Number of Positions	8			
Number of Rows	1			
PCB Mount Orientation	Horizontal			
Body Features				
Primary Product Color	Black			
Contact Features				

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Contact Mating Area Plating Material Thickness	2 µm[80 µin]	
Contact Mating Area Plating Material Finish	Matte	
Contact Mating Area Plating Material	Tin	
Contact Type	Pin	
Contact Current Rating (Max)	15 A	
Termination Features		
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
PCB Mount Alignment Type	None	
Mating Alignment Type	Polarization	
Mating Retention	With	
PCB Mount Retention Type	Retention Leg	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
PCB Mount Alignment	Without	
PCB Mount Retention	With	

Housing Features

Housing Material	Polyester GF	
Centerline (Pitch)	3.81 mm[.15 in]	
Usage Conditions		
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]	
Operation/Application		
Circuit Application	Power & Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Type	Box, Tube	
Product Compliance For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	

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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

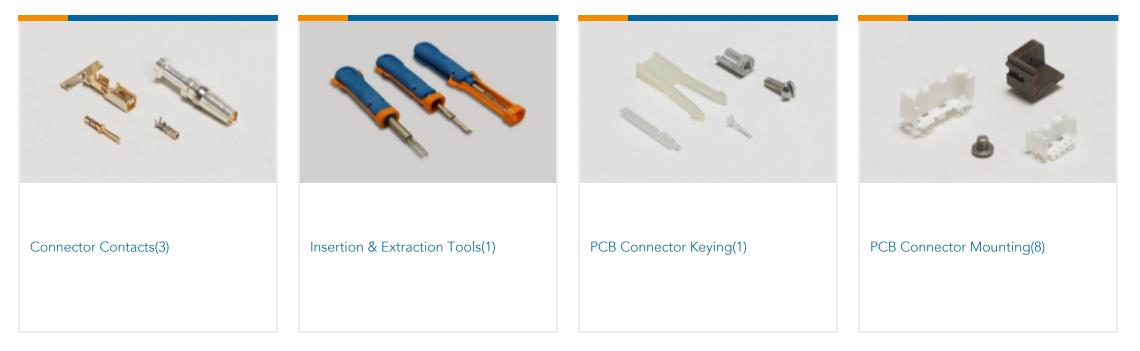
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

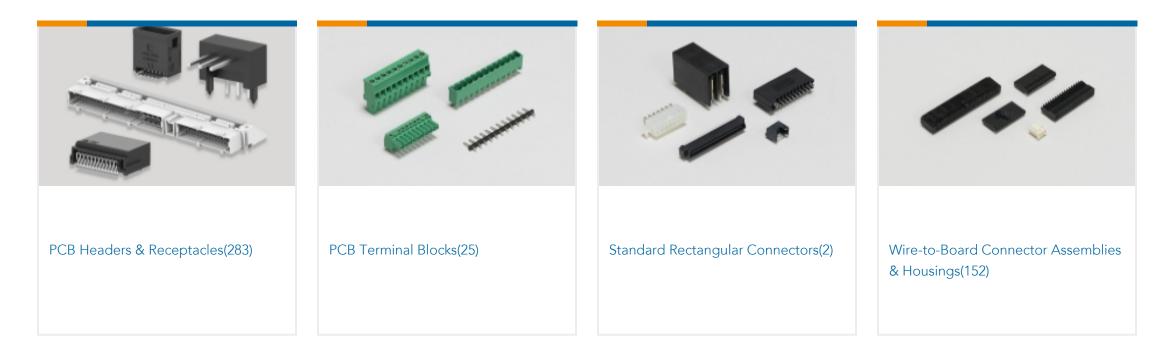


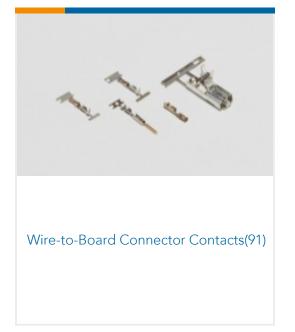
Also in the Series | Dynamic 3000 Series



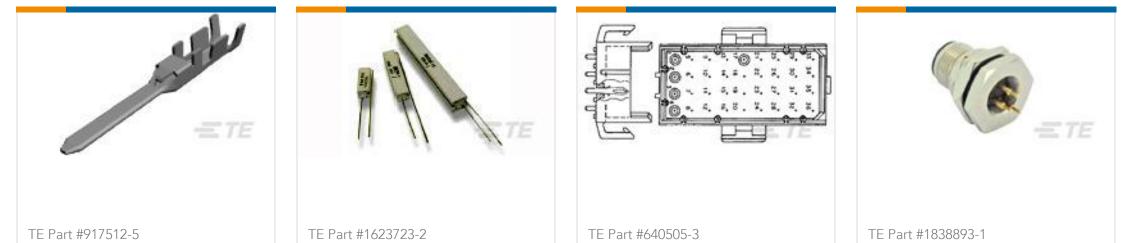
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Customers Also Bought



DYNAMIC D-3 TAB CONT. 2L PRE- TIN L/P	SBCH 15 1K5 5%	24P MR HDR ASSY V0	M12 Mtl MALE PNL CONN. Sldr Re
	ETE	8	
		-ETE	
TE Part #170376-3 EIS CONN. PIN CONTACT	TE Part #1986711-2 SCREWLESS, SW,2P,5.0 PCB	TE Part #2317659-9 AV25 DPM 3A MOVING RING POWER R&G 12V FL	TE Part #3-582118-9 TEST PROBE REC130 BI WHT GPBR



Documents

PCB Mount Header, Horizontal, Wire-to-Board, 8 Position, 3.81 mm [.15 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Dynamic 3000 Series



Product Drawings 3.81 DYNAMIC 8P D3100S

Japanese

CAD Files

3D PDF

English

Customer View Model ENG_CVM_1-178297-5_B.3d_igs.zip

English

Customer View Model

ENG_CVM_1-178297-5_B.3d_stp.zip

English

Customer View Model

ENG_CVM_1-178297-5_B.2d_dxf.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages 1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

Japanese

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

English

Product Specifications

Product Specification

English

Agency Approvals TUV Certificate

English